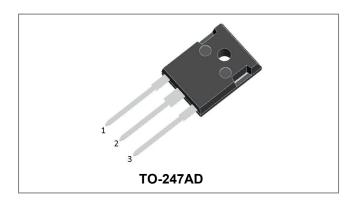






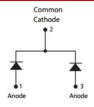
MBR6060WT SCHOTTKY RECTIFIER



Features

- 150 °C T_J operation
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- . All SMC parts are traceable to the wafer lot
- · Additional testing can be offered upon request

Circuit Diagram



Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Center tap configuration

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	60	V
Average Rectified Forward Current	I _{F (AV)}	50% duty cycle @Tc=135°C, rectangular wave form	30(Per Leg) 60(Per Device)	Α
Peak One Cycle Non-Repetitive Surge Current(Per Leg)	I _{FSM}	8.3ms, Half Sine pulse	510	Α

Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop	V _{F1}	@ 30A, Pulse, T _J = 25℃	0.58	0.69	V
(Per Leg)*	V _{F2}	@ 30A, Pulse, T _J = 125℃	0.51	0.64	V
Reverse Current	I _{R1}	@V _R = rated V _R ,T _J = 25°C	0.2	1.0	mA
(Per Leg)*	I _{R2}	@V _R = rated V _R ,T _J = 125℃	50	150	mA
Junction Capacitance(Per Leg)	Ст	$@V_R = 5V, T_C = 25^{\circ}C,$ $f_{SIG} = 1MHz$	950	1400	pF
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

 $^{^*}$ Pulse width < 300 μ s, duty cycle < 2%

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Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T _{stg}	-	-55 to +150	°C
Typical Thermal Resistance Junction to	Rejc	DC operation	1.0(Per Leg)	°C/W
Case			0.5(Per Package)	C/VV
Typical Thermal Resistance	Recs	Mounting surface,smooth and	0.24	°C/W
Case to Heat Sink	1 1000	greased	· - · - · · · · · · · · · · · · ·	0, 11
Approximate Weight	wt	-	6.28	g
Case Style	TO-247AD			

Ratings and Characteristics Curves

Typical Forward Characteristics Typical Reverse Characteristics 10² 10² (MA) 125°C 10¹ 100 °C 10⁰ 75 °C **⋽** 10¹ 50 °C 10⁻¹ 10⁻² 25 °C 125 °C Instantaneous Reverse Confent - I 10⁻³ 0 10 20 30 50 60 25 °C Reverse Voltage - V _R (V) 10⁰ **Typical Junction Capacitance** Instantaneous Forward Current - I 1200 1100 1000 900 800 700 600 500 400 300 200 0.0 0.2 0.4 0.6 8.0 Junction Ca 40 Forward Voltage Drop - V $_{\rm F}$ (V) Reverse Voltage - V R (V)

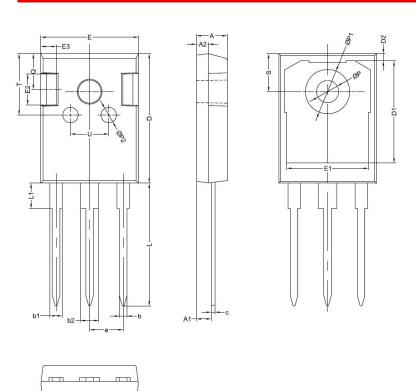
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Mechanical Dimensions TO-247AD



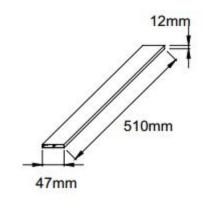
CVMDOL	Millimeters			
SYMBOL	MIN.	TYP.	MAX.	
Α	4.80	5.00	5.20	
A1	2.20	2.41	2.61	
A2	1.90	2.00	2.10	
b	1.10	1.20	1.40	
b1	1.80	2.00	2.20	
b2	2.80	3.00	3.20	
С	0.50	0.60	0.75	
D	20.30	21.00	21.20	
D1		16.55		
D2		1.20		
Е	15.45	15.80	16.00	
E1		13.30		
E2		5.00		
E3		2.50		
е		5.44		
L	19.42	19.92	20.70	
<u>L1</u> P		4.13		
	3.50	3.60	3.70	
P1	7.1		7.40	
P2		2.50		
Q		5.80		
Q S T	6.05	6.15	6.25	
T		10.00		
U		6.20		

Ordering Information:

Device	Package	Shipping	
MBR6060WT	TO-247AD(Pb-Free)	25pcs / tube	

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Tube Specification



Marking Diagram



Where XXXXX is YYWWL

MBR = Device Type = Forward Current (60A) = Reverse Voltage (60V) = Configuration WT

SSG = SSG = Year = Week ww = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

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